

H7P1002DL-VB Datasheet

P-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)	
- 100	0.100 at V _{GS} = - 10 V	- 16	11.7	
- 100	0.120 at V _{GS} = - 4.5 V	- 15	11.7	

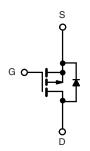
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R_q and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- Power Switch
- DC/DC Converters



P-Channel MOSFET

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0		
		Drain Connected to Drain-Tab
G D	S	
Top Vie	w	

ABSOLUTE MAXIMUM RATINGS T _C = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 100			
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 25 °C	1-	- 16		
Continuous Diain Current (1) = 150 °C)	T _C = 70 °C	- I _D	- 14		
Pulsed Drain Current	I _{DM}	- 50	Α		
Avalanche Current	I _{AS}	- 18			
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	16.2	mJ	
	T _C = 25 °C	Б	32.1 ^b	W	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	- P _D	2.5		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W	
Junction-to-Case (Drain)	R _{thJC}	3.9	C/VV	

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		,					
Drain-Source Breakdown Voltage	V _{DS}	V_{DS} $V_{DS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$ -100				.,	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA	
		V _{DS} = - 100 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 100 V, V _{GS} = 0 V, T _J = 125 °C			- 50	0 μΑ	
		V _{DS} = - 100 V, V _{GS} = 0 V, T _J = 150 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 15			Α	
	_	V _{GS} = - 10 V, I _D = - 3.6 A		0.100		_	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.4 A		0.120		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		12		S	
Dynamic ^b				l			
Input Capacitance	C _{iss}			1055		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 50 V, f = 1 MHz		65			
Reverse Transfer Capacitance	C _{rss}	1		41			
·	Qg	V _{DS} = - 50 V, V _{GS} = - 10 V, I _D = - 3.6 A		23.2	34.8	nC	
Total Gate Charge ^c				11.7	17.6		
Gate-Source Charge ^c	Q_{gs}	V _{DS} = - 50 V, V _{GS} = - 4.5 V, I _D = - 3.6 A		3.5			
Gate-Drain Charge ^c	Q _{gd}	1		4.8			
Gate Resistance	R_g	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			7	14		
Rise Time ^c	t _r	$V_{DD} = -50 \text{ V}, R_L = 17.2 \Omega$		12	18		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 2.9 A, V_{GEN} = - 10 V, R_g = 1 Ω		33	50	ns	
Fall Time ^c	t _f	1		9	18	1	
Drain-Source Body Diode Ratings ar	nd Characteri	stics T _C = 25 °C ^b		•			
Continuous Current	I _S				- 8.8	Α	
Pulsed Current	I _{SM}				- 15		
Forward Voltage ^a	V _{SD}	I _F = - 2.9 A, V _{GS} = 0 V		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			50	75	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	Α	
Reverse Recovery Charge	Q _{rr}	┥		98	147	nC	

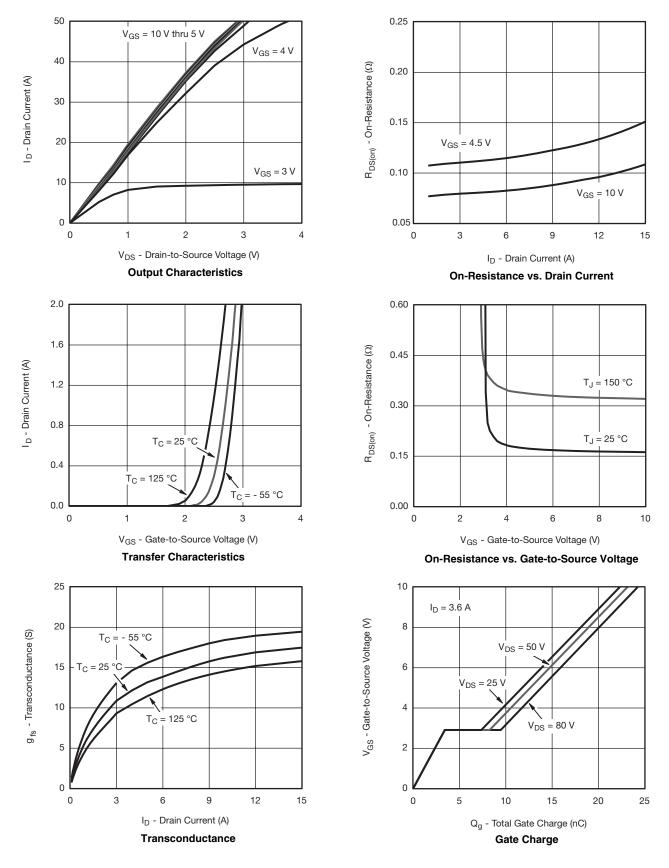
Notes:

- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

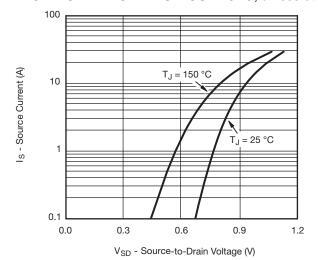


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

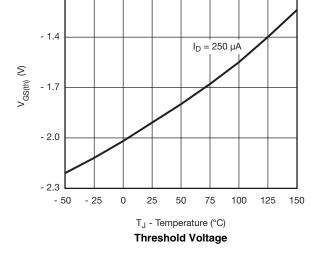


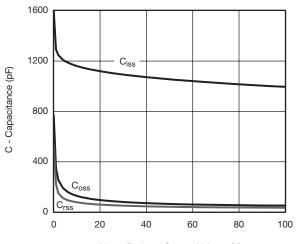


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

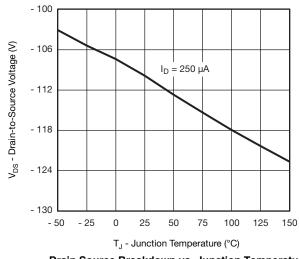


Source-Drain Diode Forward Voltage

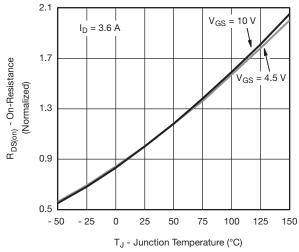




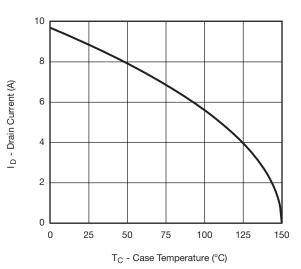
 V_{DS} - Drain-to-Source Voltage (V) $\label{eq:capacitance}$



Drain Source Breakdown vs. Junction Temperature



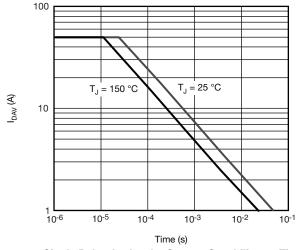
On-Resistance vs. Junction Temperature

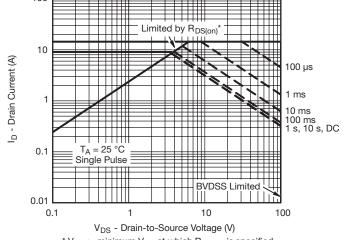


Current Derating

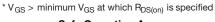


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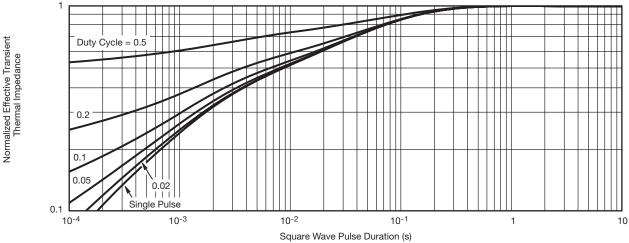




Single Pulse Avalanche Current Capability vs. Time







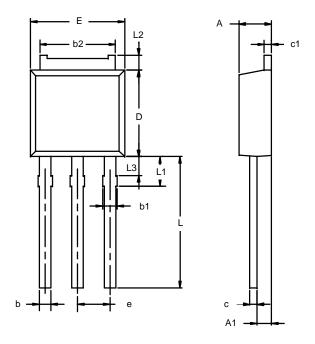
Normalized Thermal Transient Impedance, Junction-to-Case

服务热线:400-655-8788

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TO-251AA



Note: Dimension L3 is for reference only	/.
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	MILLIMETERS		INC	HES
Dim	Min	Max	Min	Max
Α	2.21	2.38	0.087	0.094
A1	0.89	1.14	0.035	0.045
b	0.71	0.89	0.028	0.035
b1	0.76	1.14	0.030	0.045
b2	5.23	5.43	0.206	0.214
С	0.46	0.58	0.018	0.023
c1	0.46	0.58	0.018	0.023
D	5.97	6.22	0.235	0.245
Е	6.48	6.73	0.255	0.265
е	2.28 BSC		0.090	BSC
L	3.89	9.53	0.153	0.375
L1	1.91	2.28	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.15	1.52	0.045	0.060



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